1.0 General Description

The AMIS-710250 (PI250MC-A6) is a contact imaging sensor (CIS) module. It is a successor module to its predecessor, AMIS-710223-A6 (PI223MC-A6) it possesses all superb qualities of its predecessor; except, it has one outstanding feature - it can operate from a single 5V supply. Like its predecessor, it is composed of 13 AMIS-720220 (PI3020) sensor chips. The AMIS-720220 is a 200 dots per inch (dpi) solid-state line imaging array, also a product of AMI Semiconductor. This imaging device is fabricated using MOS imaging sensor technology for its high-speed performance and high sensitivity. Like its predecessor, the AMIS-710250 is suitable for scanning A6 size (104mm) documents with 8 dots per millimeter (dpm) resolution. Applications include ticket, check and card scanners, a variety of mark readers and other automation equipment.

2.0 Key Features

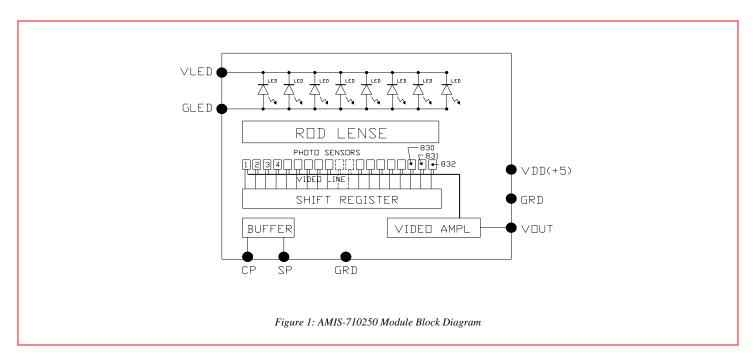
- Low power-single power supply at 5.0V
- · Light source, lens and sensor are integrated into a single module
- 8dpm resolution, 104mm scanning length
- High speed page scan up to 167µsec/line @ 5MHz pixel rate with internal optical modification (optional feature)
- · Wide dynamic range
- Analog output
- Yellow-Green LED light source
- Compact size

 14mm x 19mm x 120mm
- · Light weight

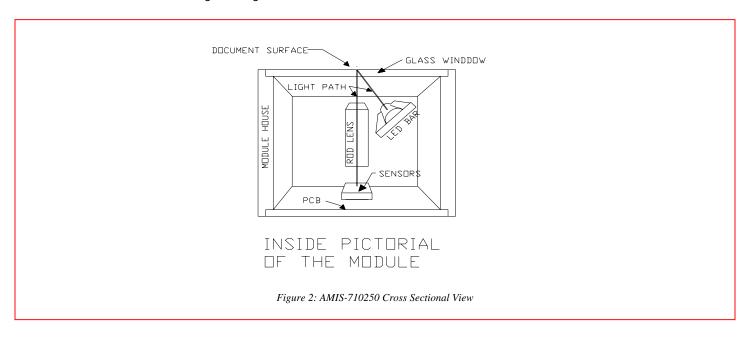
3.0 Functional Description

The AMIS-710250 consists of 13 imaging array sensors that are cascaded to provide 832 photo-detectors. Each sensor has its associated multiplex switches and a digital shift register that controls its sequential readout. Each sensor also contains a chip-select switch so that each following chip is accessed sequentially as its predecessor chip completes its scan. These chips are mounted on a printed circuit board (PCB) along with clock buffers and video signal amplifier. The only change from its predecessor module is in this amplifier. It as been slightly altered from its predecessor module to gain the single supply feature, see Figure 1.





The PCB containing the imaging array is enclosed in a module housing, along with a one-to-one graded indexed micro lens array that focuses the scanned documents' image onto the sensing line of the sensor chips. The document is illuminated with a LED light source which is also mounted in the housing. See Figure 2.



This pictorial cross section shows the LED bar light source and its illumination path. The light on the document reflects images on the document. The reflected images focus through the micro lens onto the chips' image sensing line where images are converted to proportional electrical charges. An on board amplifier processes these signal charges into proportional video signal voltages, which are sent out to the output video port.

All components are housed in a small plastic housing and covered with a glass window. This cover glass not only serves to protect all of the critical components within the housing from dust, but, along with micro lens, it determines the depth-of-focus because it lies in the optical path.

4.0 Pin Out Description

There is one connector located at the end of the module. The outline of the module in Figure 4 of the mechanical section illustrates the connector location. With the module window facing down on a flat surface, with the viewer looking down on backside of the module and with the connector's pins facing viewer, the connector is located on the right-hand end of the module. The connector is a 1.25mm single 10-pin row. Its I/O designation is provided in Table 1. Pin number 1 location is indicated on the module outline.

Table 1: I/O Designation

Pin Number	Symbol	Names and Functions
1	Vout	Analog video output
2	Gnd	Ground; 0V
3	Vdd (+5V)	Positive power supply
4	NA	Not used
5	Gnd	Ground; 0V
6	SP	Shift register start pulse
7	Gnd	Ground; 0V
8	СР	Sampling clock pulse
9	GLED	Ground for the light source; 0V
10	VLED	Supply for the light source

5.0 Absolute Maximum Rating

The following is a table of absolute maximum parameters. These parameters should not be used in prolonged operation.

Table 2: Absolute Maximum Rating

Parameter	Symbols	Maximum Rating	Units
Power supply	Vdd	7.0	V
	Idd	50	mA
	VLED	5.7	V
	ILED	600	mA
Input clock pulse (high)	Vih	Vdd	V
Input clock pulse (low)	Vil	-0.5	V

Table 3: Operating Environment

Parameter	Symbols	Maximum Rating	Units
Operating temperature	Тор	0 to 50	°C
Operating humidity	Нор	10 to 85	%
Storage temperature	Tstg	-25 to 85	°C
Storage humidity	Hstg	5 to 95	%

6.0 Electro-Optical Characteristics (25°C)

Table 4: Electro-Optical Characteristics (25°C)

Parameter	Symbol	Parameter	Units	Note
Number of photo detectors		832	Elements	
Pixel-to-pixel spacing		125	μm	
Line scanning rate	Tint ⁽¹⁾	420	μsec	@ 2.0MHz clock frequency
Clock frequency ⁽²⁾	Fclk	2	MHz	See Note 2 for 5.0MHz operation
Bright output voltage ⁽³⁾	Video output	1.0	V	Specified for 420µsec
Bright output non-uniformity ⁽⁴⁾	Up	<+/-30	%	
Adjacent pixel non-uniformity(5)	Uadj	<25	%	
Dark non-uniformity ⁽⁶⁾	Ud	<50	mV	
Dark output voltage	Vd	200 <vd<300< td=""><td>mV</td><td></td></vd<300<>	mV	
Modulation transfer function(1)	MTF	>50	%	See Note 7 for MTF & DOF

Definition:

- Tint: line scanning rate or integration time. Tint is determined by the interval of two SP. See Note 2 for the high scanning speed operation.
- Fclk: main clock frequency. The call out is at 2.0MHz, but electrically module reliably operates to 5.0MHz. However, it must be optically modified to obtain the minimum integration time of 167µsec. This modification is offered as a user's option.
- $Vpavg = \sum Vp(n)/832$ $Up = [(Vpmax Vp) / Vp] \times 100\% \text{ or } [(Vp Vpmin) / Vp] \times 100\%$
- Upadj = MAX[| (Vp(n) Vp(n+l) | / Vp(n)] x 100%
- Upadj is the nonuniformity percentage pixel to pixel.
- Ud = Vdmax Vdmin
 - Vdmin is the minimum output on a black document.
 - Vdmax: maximum output voltage of black document
- MTF = [(Vmax Vmin) / (Vmax + Vmin)] x 100 [%]. Depth of focus, DOF, range is defined with the MTF. MTF is measure at glass surface and at 0.4mm from the glass > 50 percent and peaks at approximately mid-point of 0.2mm.
 - Vmax: maximum output voltage at 50lp/inch (At 1/2 of the optical Nyquest frequency)
- Vmin: minimum output voltage at 50lp/inch lp / inch: line pair per inch



Table 5: Recommended Operating Conditions (25°C)

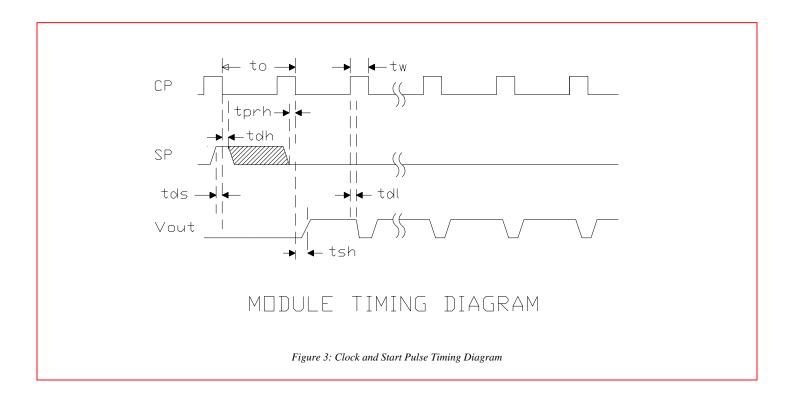
Item	Symbol	Min.	Mean	Max.	Units
Power supply	Vdd	4.5	5.0	5.5	V
	VLED	4.5	5.0	5.5	V
	ldd	22	25	30	ma
	ILED	200	380	450	ma
Input voltage at digital high	Vih	Vdd-1.0	Vdd-0.5	Vdd	V
Input voltage at digital low	Vil	0		0.6	V
Clock frequency	Fclk		2.0	5.0	MHz
Clock pulse high duty cycle ⁽¹⁾		25			%
Clock pulse high duration ⁽¹⁾		50			ns
Integration time ⁽²⁾	Tint	0.167		5.0	ms
Operating temperature	Тор		25	50	Č

Notes:

- These duty cycle and high duration are for a 5.0MHz clock rate.

 Tint (min.) is the lowest line integration time available at a 5.0MHz clock rate with internal optical modifications. See Note 2 under Table 4.

7.0 Switching Characteristics (25°C)



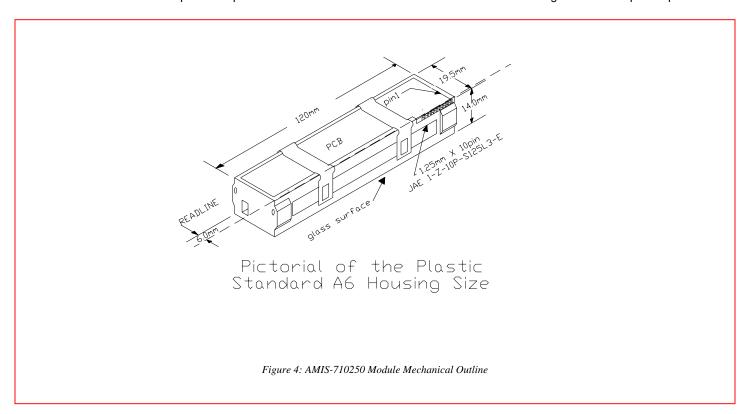
The switching characteristics for the I/O clocks are shown in Figure 3. Its corresponding timing symbol definitions are given in Table 6.

Table 6: Symbol Definition for the Above Timing Diagram

Item	Symbol	Min.	Тур.	Max.	Units
Clock cycle time	to	0.2		4.0	μS
Clock pulse width	tw	50			ns
Clock duty cycle		25		75	%
Prohibit crossing time of SP	tprh	15			ns
Data setup time	tds	20			ns
Data hold time	tdh	20			ns
Signal delay time	tdl	50			ns
Signal settling time	tsh	120			ns

8.0 AMIS-710250 Module and its Mechanical Dimensions

The sketch of this module is to provide a pictorial of the module size and structure. A detailed drawing is available upon request.



9.0 Company or Product Inquiries

For more information about AMI Semiconductor, our technology and our product, visit our Web site at: http://www.amis.com

North America Tel: +1.208.233.4690 Fax: +1.208.234.6795

Europe

Tel: +32 (0) 55.33.22.11 Fax: +32 (0) 55.31.81.12

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